

### LM759/LM77000 Power Operational Amplifiers

#### **General Description**

The LM759 and LM77000 are high performance operational amplifiers that feature high output current capability. The LM759 is capable of providing 325 mA and the LM77000 providing 250 mA. Both amplifiers feature small signal characteristics that are better than the LM741. The amplifiers are designed to operate from a single or dual power supply with an input common mode range that includes the negative supply. The high gain and high output power provide superior performance. Internal current limiting, thermal shutdown, and safe area compensation are employed making the LM759 and LM77000 essentially indestructible.

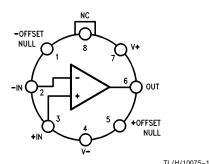
#### **Features**

- Output current LM759—325 mA minimum LM77000—250 mA minimum
- Internal short circuit current limiting
- Internal thermal overload protection
- Internal output transistors safe-area protection
- Input common mode voltage range includes ground or negative supply

#### **Applications**

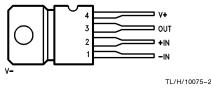
- Voltage regulators
- Audio amplifiers
- Servo amplifiers
- Power drivers

#### **Connection Diagrams and Ordering Information**



Lead 4 connected to case.

Top View
Order Number LM759MH, LM759CH or LM759H/883
See NS Package Number H08C



Top View

Order Number LM759CP or LM77000CP See NS Package Number P04A

#### **Absolute Maximum Ratings**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature Range

-65°C to +175°C -65°C to +150°C Metal Can Plastic Package

Operating Junction Temperature Range Military (LM759M)  $-55^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$ Commercial (LM759C, LM77000C) 0°C to +125°C

Lead Temperature

Metal Can (soldering, 60 sec) 300°C 265°C Plastic Package (soldering, 10 sec)

Internal Power Dissipation (Note 1) Internally Limited Supply Voltage  $\pm\,18V$ Differential Input Voltage 30V Input Voltage (note 2)  $\pm\,15V$ 

#### LM759

### **Electrical Characteristics** $T_J = 25^{\circ}C$ , $V_{CC} = \pm 15V$ , unless otherwise specified

Symbol	Parameter		Conditions	Min	Тур	Max	Units
V <sub>IO</sub>	Input Offset Voltage		$R_S \le 10 \text{ k}\Omega$		1.0	3.0	mV
I <sub>IO</sub>	Input Offset Current				5.0	30	nA
I <sub>IB</sub>	Input Bias Current				50	150	nA
Z <sub>I</sub>	Input Impedance			0.25	1.5		МΩ
Icc	Supply Current				12	18	mA
V <sub>IR</sub>	Input Voltage Range			$V^+-2V$ to $V^-$	$V^+-$ 2V to $V^-$		V
los	Output Short Circuit C	urrent	$ V_{CC}-V_O =30V$		±200		mA
I <sub>O PEAK</sub>	Peak Output Current		$3.0V \le \left V_{CC} - V_{O}\right  \le 10V$	±325	±500		mA
A <sub>VS</sub>	Large Signal Voltage	Gain	$R_L \geq 50\Omega, V_O = \pm 10V$	50	200		V/mV
TR	Transient Response	Rise Time	$R_L = 50\Omega, A_V = 1.0$		300		ns
		Overshoot			5.0		%
SR	Slew Rate		$R_L = 50\Omega, A_V = 1.0$		0.6		V/µs
BW	Bandwidth		A <sub>V</sub> = 1.0		1.0		MHz
The following specifications apply for $-55^{\circ}\text{C} \le \text{T}_{\text{J}} \le +150^{\circ}\text{C}$							
V <sub>IO</sub>	Input Offset Voltage		$R_S \le 10 \text{ k}\Omega$			4.5	mV
I <sub>IO</sub>	Input Offset Current					60	nA
I <sub>IB</sub>	Input Bias Current					300	nA
CMRR	Common Mode Rejec	tion Ratio	$R_S \le 10 \text{ k}\Omega$	80	100		dB
PSRR	Power Supply Rejection	Power Supply Rejection Ratio		80	100		dB
A <sub>VS</sub>	Large Signal Voltage	Gain	$R_L \ge 50\Omega, V_O = \pm 10V$	25	200		V/mV
V <sub>OP</sub>	Output Voltage Swing		$R_L = 50\Omega$	±10	± 12.5		V

# **LM759C** Electrical Characteristics $T_J = 25^{\circ}\text{C}, V_{CC} = \pm 15\text{V}, \text{ unless otherwise specified}$

Symbol	Parameter		Conditions	Min	Тур	Max	Units
V <sub>IO</sub>	Input Offset Voltage		$R_S \leq 10 \text{ k}\Omega$		1.0	6.0	mV
I <sub>IO</sub>	Input Offset Current	Input Offset Current			5.0	50	nA
I <sub>IB</sub>	Input Bias Current				50	250	nA
Z <sub>I</sub>	Input Impedance			0.25	1.5		МΩ
Icc	Supply Current				12	18	mA
V <sub>IR</sub>	Input Voltage Range			$ m V^+ - 2V$ to $ m V^-$	$V^+-2V$ to $V^-$		V
los	Output Short Circuit Current		$ V_{CC}-V_O =30V$		±200		mA
IO PEAK	Peak Output Current		$3.0V \le \left V_{CC} - V_{O}\right  \le 10V$	±325	±500		mA
A <sub>VS</sub>	Large Signal Voltage Gain		$R_L \ge 50\Omega, V_O = \pm 10V$	25	200		V/mV
TR	Transient Response	Rise Time	$R_L = 50\Omega$ , $A_V = 1.0$		300		ns
		Overshoot			10		%
SR	Slew Rate		$R_L = 50\Omega$ , $A_V = 1.0$		0.5		V/µs
BW	Bandwidth		A <sub>V</sub> = 1.0		1.0		MHz
The follo	The following specifications apply for $0^{\circ} \le T_{J} \le +125^{\circ}C$						
V <sub>IO</sub>	Input Offset Voltage		$R_{S} \le 10 \text{ k}\Omega$			7.5	mV
I <sub>IO</sub>	Input Offset Current					100	nA
I <sub>IB</sub>	Input Bias Current					400	nA
CMRR	Common Mode Rejection Ratio		$R_S \leq 10 \text{ k}\Omega$	70	100		dB
PSRR	Power Supply Rejection Ratio		$R_S \leq 10 \ k\Omega$	80	100		dB
A <sub>VS</sub>	Large Signal Voltage Gain		$R_L \geq 50\Omega, V_O =  \pm  10V$	25	200		V/mV
V <sub>OP</sub>	Output Voltage Swing		$R_L = 50\Omega$	±10	± 12.5		V

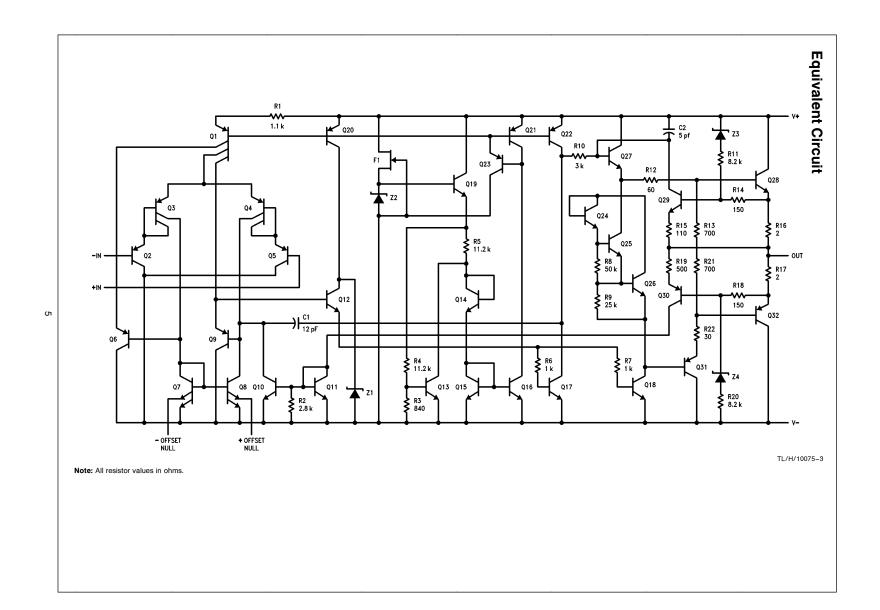
# LM77000 Electrical Characteristics $T_J=25^{\circ}\text{C}, V_{CC}=\pm15\text{V}, \text{unless otherwise specified}$

Symbol	Parameter		Conditions	Min	Тур	Max	Units
V <sub>IO</sub>	Input Offset Voltage		$R_S \le 10 \text{ k}\Omega$		1.0	8.0	mV
I <sub>IO</sub>	Input Offset Current				5.0	50	nA
$I_{IB}$	Input Bias Current				50	250	nA
Z <sub>I</sub>	Input Impedance			0.25	1.5		MΩ
Icc	Supply Current				12	18	mA
$V_{IR}$	Input Voltage Range			+ 13 to V <sup>-</sup>	+ 13 to V-		V
los	Output Short Circuit Current		$ V_{CC}-V_O =30V$		±200		mA
IO PEAK	Peak Output Current		$3.0V \leq \left V_{CC} - V_{O}\right  \leq 10V$	±250	± 400		mA
A <sub>VS</sub>	Large Signal Voltage Gain		$R_L \ge 50\Omega, V_O = \pm 10V$	25	200		V/mV
TR	Transient Response	Rise Time	$R_L = 50\Omega, A_V = 1.0$		300		ns
		Overshoot			10		%
SR	Slew Rate		$R_L = 50\Omega, A_V = 1.0$		0.5		V/μs
BW	Bandwidth		A <sub>V</sub> = 1.0		1.0		MHz
The follow	ving specifications apply f	or $0^{\circ} \leq T_{J} \leq +$	125°C				
$V_{IO}$	Input Offset Voltage		$R_S \leq 10 \text{ k}\Omega$			10	mV
I <sub>IO</sub>	Input Offset Current					100	nA
I <sub>IB</sub>	Input Bias Current					400	nA
CMR	Common Mode Rejection		$R_S \le 10 \text{ k}\Omega$	70	100		dB
PSRR	Power Supply Rejection Ratio		Bo < 10 kO	80	100		dВ

Note 1: Although the internal power dissipation is limited, the junction temperature must be kept below the maximum specified temperature in order to meet data sheet specifications. To calculate the maximum junction temperature or heat sink required, use the thermal resistance values which follow the Equivalent Circuit Schematic.

Note 2: For a supply voltage less than 30V between V+ and V-, the absolute maximum input voltage is equal to the supply voltage.

Note 3: For military electrical specifications RETS759X are available for LM759H.



Package	Typ θJC °C/W	Max θJC °C/W	Typ θJA °C/W	Max <sup>θ</sup> JA °C/W
Plastic Package (P)	8.0	12	75	80
Metal Can (H)	30	40	120	150

$$\begin{split} \mathsf{P}_{\mathsf{D}\,\mathsf{Max}} &= \frac{\mathsf{T}_{\mathsf{J}\,\mathsf{Max}} - \mathsf{T}_{\mathsf{A}}}{\theta_{\mathsf{JC}} + \theta_{\mathsf{CA}}}\,\mathsf{or} \\ &= \frac{\mathsf{T}_{\mathsf{J}\,\mathsf{Max}} - \mathsf{T}_{\mathsf{A}}}{\theta_{\mathsf{JA}}}\,\mathsf{(without\,a\,heat\,sink)} \\ \theta_{\mathsf{CA}} &= \theta_{\mathsf{CS}} + \theta_{\mathsf{SA}} \end{split}$$

#### Solving T<sub>J</sub>:

$$T_J = T_A + P_D (\theta_{JC} + \theta_{CA})$$
 or   
=  $T_A + P_D \theta_{JA}$  (without a heat sink)

#### Where:

T<sub>J</sub> = Junction Temperature

T<sub>A</sub> = Ambient Temperature

P<sub>D</sub> = Power Dissipation

 $\theta_{JA}$  = Junction to ambient thermal resistance

 $\theta_{\rm JC}$  = Junction to case thermal resistance

 $\theta_{\text{CA}}$  = Case to ambient thermal resistance

 $\theta_{\rm CS}$  = Case to heat sink thermal resistance

 $\theta_{SA}$  = Heat sink to ambient thermal resistance

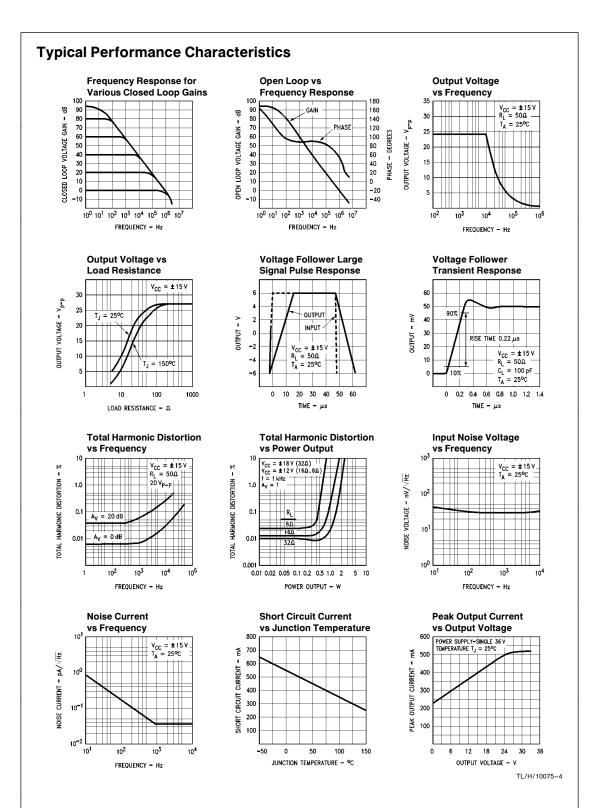
#### **Mounting Hints**

#### Metal Can Package (LM759CH/LM759MH)

The LM759 in the 8-Lead TO-99 metal can package must be used with a heat sink. With  $\pm 15\mathrm{V}$  power supplies, the LM759 can dissipate up to 540 mW in its quiescent (no load) state. This would result in a  $100^{\circ}\mathrm{C}$  rise in chip temperature to  $125^{\circ}\mathrm{C}$  (assuming a  $25^{\circ}\mathrm{C}$  ambient temperature). In order to avoid this problem, it is advisable to use either a slip on or stud mount heat sink with this package. If a stud mount heat sink is used, it may be necessary to use insulating washers between the stud and the chassis because the case of the LM759 is internally connected to the negative power supply terminal.

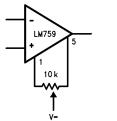
#### Plastic Package (LM759CP/LM77000CP)

The LM759CP and LM77000CP are designed to be attached by the tab to a heat sink. This heat sink can be either one of the many heat sinks which are commercially available, a piece of metal such as the equipment chassis, or a suitable amount of copper foil as on a double sided PC board. The important thing to remember is that the negative power supply connection to the op amp must be made through the tab. Furthermore, adequate heat sinking must be provided to keep the chip temperature below 125°C under worst case load and ambient temperature conditions.



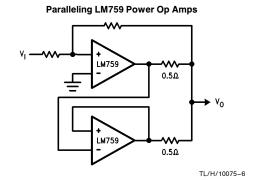
## **Applications**

#### Offset Null Circuit

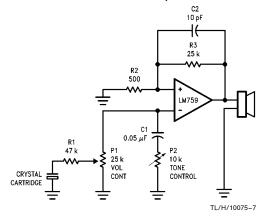


#### TL/H/10075-5

## **Audio Applications**



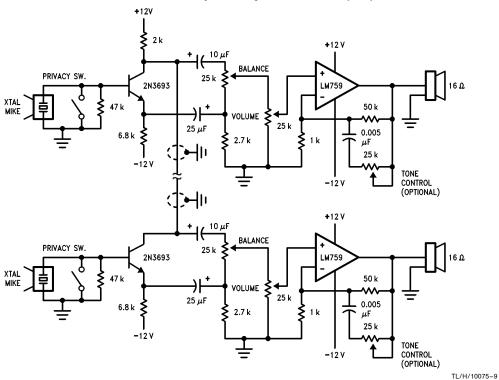
#### **Low Cost Phono Amplifier**



Speaker Impedance (Ohms)	Output Power (Watts)	Min Supply (Volts)	V <sub>OP-P</sub> (Volts)	
4	0.18	9	2.4	
8	0.36	12	4.8	
16	0.72	15	9.6	
32	1.44	25	19.2	

### Applications (Continued)

#### Bi-Directional Intercom System Using the LM759 Power Op Amp



#### Features:

Circuit Simplicity

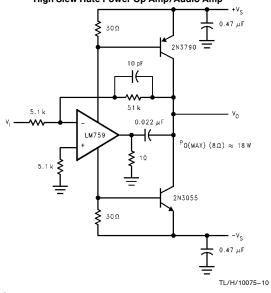
1 Watt of Audio Output

Duplex operation with only one two-wire cable as interconnect.

Note 1: All resistor values in ohms.

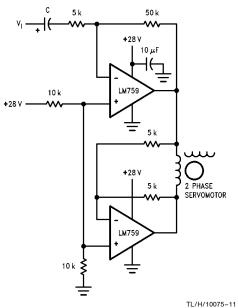
#### **Applications** (Continued)

#### High Slew Rate Power Op Amp/Audio Amp



#### **Servo Applications**

#### AG Servo Amplifier—Bridge Type



#### Features:

High Slew Rate 9 V/ $\mu$ s High 3 dB Power Bandwidth 85 kHz 18 Watts Output Power into an  $8\Omega$  load. Low Distortion—0.2%, 10 Vrms, 1 kHz into  $8\Omega$  Design Consideration

 $A_V \ge 10$ 

#### Features:

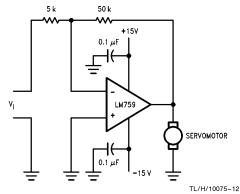
Gain of 10

Use of LM759 Means Simple Inexpensive Circuit

#### **Design Considerations:**

325 mA Max Output Current

#### DC Servo Amplifier



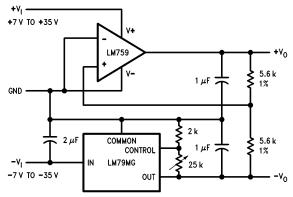
#### Features:

Circuit Simplicity One Chip Means Excellent Reliability Design Considerations I  $_{\rm O} \leq 325$  mA

Note 1: All resistor values in ohms.

### **Regulator Applications**

#### Adjustable Dual Tracking Regulator



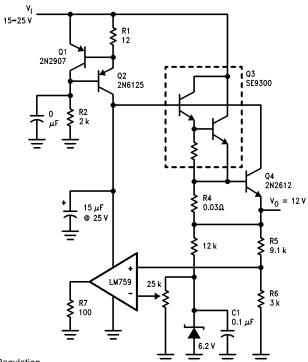
TL/H/10075-13

#### Features:

Wide Output Voltage Range ( $\pm 2.2V$  to  $\pm 30V$ ) Excellent Load Regulation  $\Delta V_O < \pm 5$  mV for  $\Delta I_O = \pm 0.2$  A Excellent Line Regulation  $\Delta V_O < \pm 2$  mV for  $\Delta V_I = 10V$ 

Note 1: All resistor values in ohms.

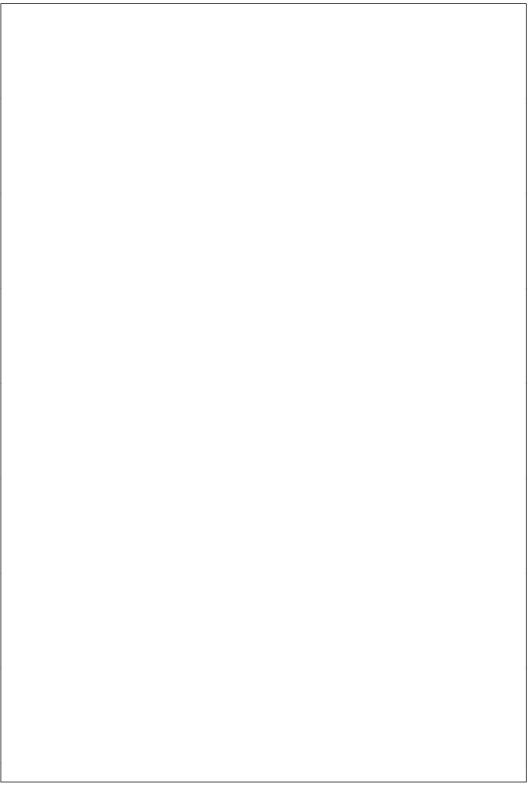
#### 10 Amp — 12 Volt Regulator



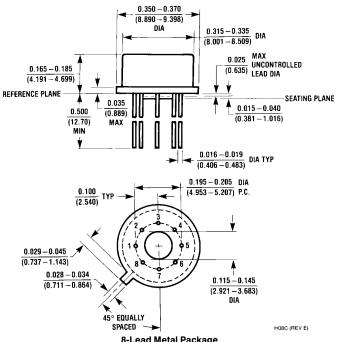
#### Features:

Excellent Load and Line Regulation
Excellent Temperature Coefficient-Depends
Largely on Tempco of the Reference Zener
Note 1: All resistor values in ohms.

TL/H/10075-14

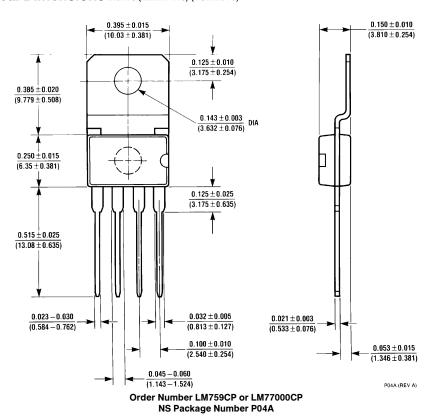






8-Lead Metal Package Order Number LM759MH, LM759CH or LM759H/883 NS Package Number H08C

#### Physical Dimensions inches (millimeters) (Continued)



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Datasheets for electronics components.

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This file is the datasheet for the following electronic components:

LM759 - http://www.ti.com/product/lm759?HQS=TI-null-null-dscatalog-df-pf-null-wwe LM77000 - http://www.ti.com/product/lm77000?HQS=TI-null-null-dscatalog-df-pf-null-wwe